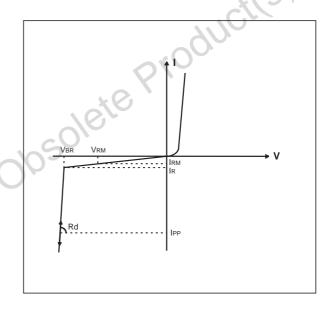
EMIF01-5250SC5

ABSOLUTE MAXIMUM RATINGS $(T_{amb} = 25 \text{ °C})$

Symbol	Parameter and test conditions	Value	Unit
V _{PP}	ESD discharge IEC61000-4-2, air discharge	15	kV
	ESD discharge IEC61000-4-2, contact discharge	8	
Tj	Junction temperature	150	°C
T _{op}	Operating temperature range	-30 to + 85	°C
T _{stg}	Storage temperature range	-55 to +150	°C
TL	Lead temperature for soldering during 10s	260	°C

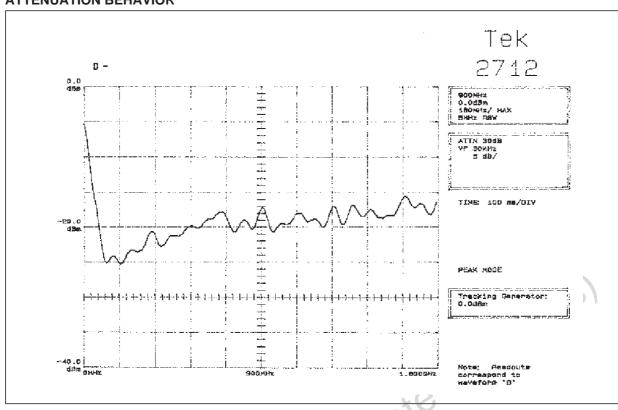
ELECTRICAL CHARACTERISTICS of the ZENER DIODE (Tamb = $25 \, ^{\circ}$ C)

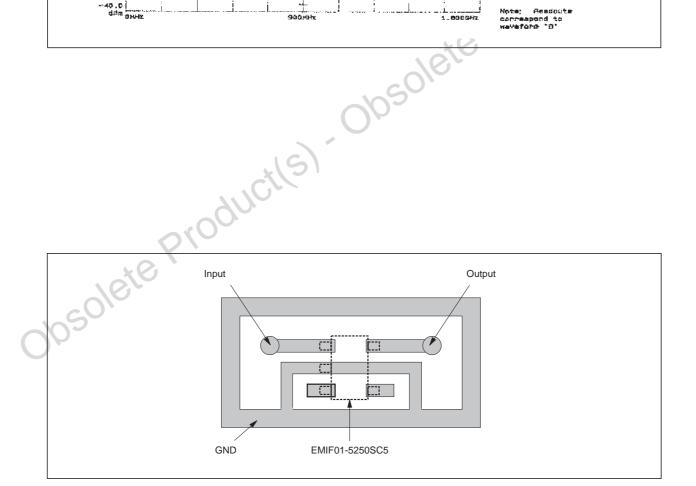
Symbol	Parameter
V _{BR}	Breakdown voltage
I _{RM}	Leakage current
Rd	Dynamic impedance
Cz	Zener capacitance
trr	Reverse recovery time



Symbol	Test conditions	Min.	Тур.	Max.	Unit
V _{BR}	$I_R = 1 \text{ mA}$	6	7	8	V
I _{RM}	$V_{RM} = 3V$			1	μΑ
Rd	$I_{pp} = 10 \text{ A}, t_p = 2.5 \mu\text{s}$		0.55		Ω
Cz	0 V bias, $V_{RMS} = 30 \text{ mV}, F = 1 \text{ MHz}$		90		pF
trr	I_F = 10 mA, dI_F/dt = 20 A/ μ s, R_L = 100 Ω , Tj = 25 °C		40		ns

ATTENUATION BEHAVIOR





ESD BEHAVIOR

Fig 2: ESD measurement conditions

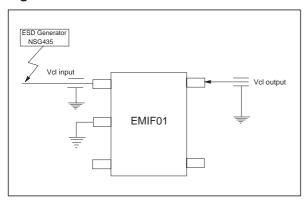
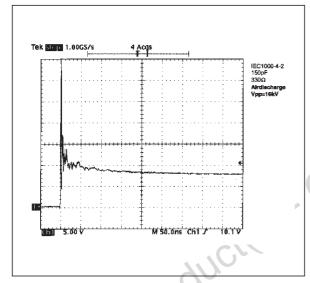
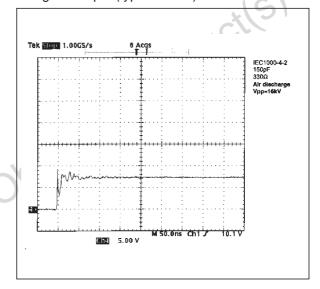


Fig 3: ESD behavior on IEC61000-4-2 air discharge at input (typical value)

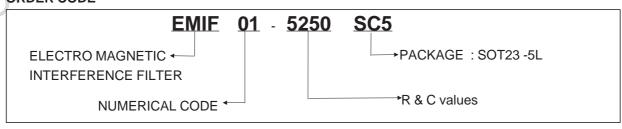


Figures 3 and 4 show the EMIF01-5250SC5 response to air and contact discharge conditions respectively at input and output pins. These figures indicate that the response is spontaneous and the output level is kept at safe operating voltages.

Fig 4: ESD behavior on IEC61000-4-2 air discharge at output (typical value)



ORDER CODE

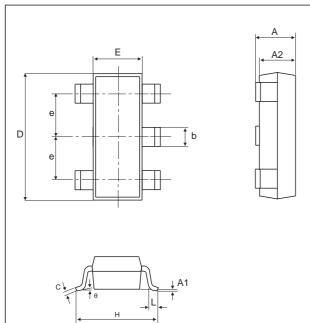


MARKING

Type & order code	Marking	Packaging	Base qty (pcs)
EMIF01-5250SC5	EMIF	tape & reel	3000

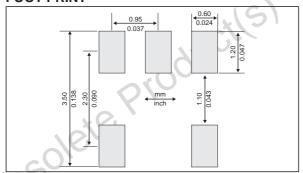
PACKAGE MECHANICAL DATA

SOT23-5L



	DIMENSIONS					
REF.	Millimeters		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	0.90		1.45	0.035		0.057
A1	0		0.10	0		0.004
A2	0.90		1.30	0.035	1	0.0512
b	0.35		0.50	0.0137	*	0.02
С	0.09		0.20	0.004		0.008
D	2.80		3.00	0.11		0.118
Е	1.50		1.75	0.059		0.0689
е		0.95			0.0374	
Н	2.60		3.00	0.102		0.118
L	0.10		0.60	0.004		0.024
θ	7		10°			10°

FOOT PRINT



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